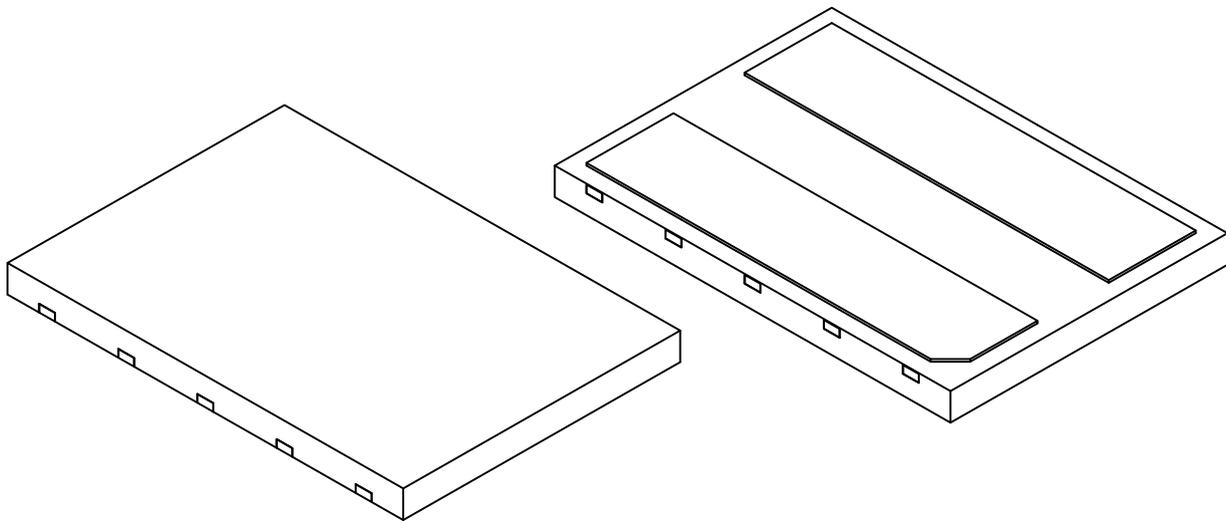


## 2-Lead Extremely-Thin Single Flatpack No-Leads (9TW) 5x3.5x0.43mm [XSFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Terminals	N		2		
Pitch	e		2.00 BSC		
Overall Height	A		0.33	0.38	0.43
Standoff	A1		0.00	-	0.05
Terminal Thickness	A3		0.127 REF		
Overall Length	D		3.50 BSC		
Overall Width	E			5.00 BSC	
Terminal Width	b		1.00	1.10	1.20
Terminal Length	L		4.50	4.60	4.70

### Notes:

1. The Pin 1 visual index feature may vary, but it must be located within the hatched area.
2. The package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. The theoretically exact value is shown without tolerances.  
REF: Reference Dimension, usually without tolerances, is for information purposes only.